CMOS Digital Integrated Circuits Silicon Monolithic

# 74HC240D,74HC244D

#### 1. Functional Description

· Octal Bus Buffer

74HC240D: INVERTED, 3-STATE OUTPUTS 74HC244D: NON-INVERTED, 3-STATE OUTPUTS

#### 2. General

 $The \, 74HC240D \, and \, 74HC244D \, are \, high \, speed \, CMOS \, OCTAL \, BUS \, BUFFERs \, fabricated \, with \, silicon \, gate \, C^2MOS \, technology.$ 

They achieve the high speed operation similar to equivalent LSTTL while maintaining the CMOS low power dissipation.

The 74HC240D is an inverting 3-state buffer and the 74HC244D are non-inverting 3-state buffers having two active-low output enables.

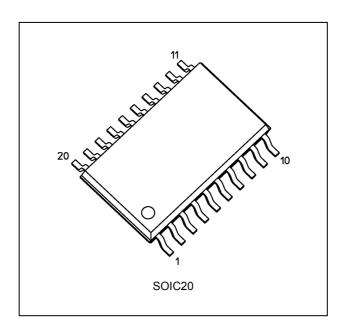
These devices are designed to be used with 3-state memory address drivers, etc.

All inputs are equipped with protection circuits against static discharge or transient excess voltage.

#### 3. Features

- (1) High speed:  $t_{pd} = 10 \text{ ns (typ.)}$  at  $V_{CC} = 6.0 \text{ V}$
- (2) Low power dissipation:  $I_{CC} = 4.0 \mu A \text{ (max)}$  at  $T_a = 25 \text{ °C}$
- (3) Balanced propagation delays:  $t_{PLH} \approx t_{PHL}$
- (4) Wide operating voltage range:  $V_{CC(opr)} = 2.0 \text{ V}$  to 6.0 V

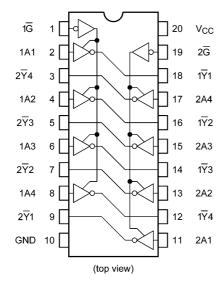
## 4. Packaging



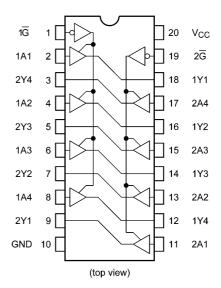
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## 5. Pin Assignment

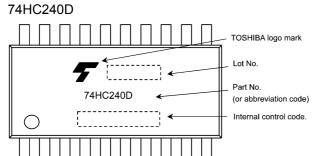
74HC240D



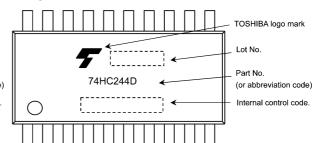
#### 74HC244D



#### 6. Marking

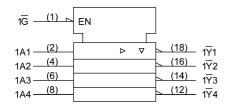


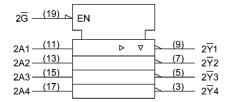
#### 74HC244D



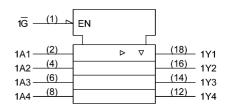
### 7. IEC Logic Symbol

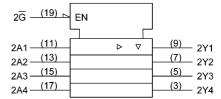
74HC240D





#### 74HC244D







#### 8. Truth Table

Input G	Input An	Output Yn	Output $\overline{Y}$ n
L	L	L	Н
L	Н	Н	L
Н	Х	Z	Z

X: Don't care
Z: High impedance
Yn: 74HC244D
\overline{Y}n: 74HC240D

#### 9. Absolute Maximum Ratings (Note)

Characteristics	Symbol	Rating	Unit
Supply voltage	V <sub>CC</sub>	-0.5 to 7.0	V
Input voltage	V <sub>IN</sub>	-0.5 to V <sub>CC</sub> + 0.5	V
Output voltage	V <sub>OUT</sub>	-0.5 to V <sub>CC</sub> + 0.5	V
Input diode current	I <sub>IK</sub>	±20	mA
Output diode current	I <sub>OK</sub>	±20	mA
Output current	l <sub>out</sub>	±35	mA
V <sub>CC</sub> /ground current	I <sub>CC</sub>	±75	mA
Power dissipation	$P_D$	500	mW
Storage temperature	T <sub>stg</sub>	-65 to 150	°C

Note: Exceeding any of the absolute maximum ratings, even briefly, lead to deterioration in IC performance or even destruction.

Using continuously under heavy loads (e.g. the application of high temperature/current/voltage and the significant change in temperature, etc.) may cause this product to decrease in the reliability significantly even if the operating conditions (i.e. operating temperature/current/voltage, etc.) are within the absolute maximum ratings and the operating ranges.

Please design the appropriate reliability upon reviewing the Toshiba Semiconductor Reliability Handbook ("Handling Precautions"/"Derating Concept and Methods") and individual reliability data (i.e. reliability test report and estimated failure rate, etc).

## 10. Operating Ranges (Note)

Characteristics	Symbol	Test Condition	Rating	Unit
Supply voltage	V <sub>CC</sub>		2.0 to 6.0	V
Input voltage	V <sub>IN</sub>		0 to V <sub>CC</sub>	V
Output voltage	V <sub>OUT</sub>		0 to V <sub>CC</sub>	V
Operating temperature	T <sub>opr</sub>		-40 to 85	°C
Input rise and fall times	t <sub>r</sub> ,t <sub>f</sub>	V <sub>CC</sub> = 2.0 V	0 to 1000	ns
		V <sub>CC</sub> = 4.5 V	0 to 500	
		V <sub>CC</sub> = 6.0 V	0 to 400	

Note: The operating ranges must be maintained to ensure the normal operation of the device. Unused inputs must be tied to either  $V_{CC}$  or GND.



## 11. Electrical Characteristics

# 11.1. DC Characteristics (Unless otherwise specified, $T_a$ = 25 °C)

Characteristics	Symbol	Test Condition		V <sub>CC</sub> (V)	Min	Тур.	Max	Unit
High-level input voltage	V <sub>IH</sub>	_		2.0	1.50	_	_	V
				4.5	3.15	_	_	]
				6.0	4.20	_	_	
Low-level input voltage	V <sub>IL</sub>	_		2.0	_	_	0.50	V
				4.5			1.35	
				6.0			1.80	
High-level output voltage	V <sub>OH</sub>	V <sub>IN</sub> = V <sub>IH</sub> or V <sub>IL</sub>	I <sub>OH</sub> = -20 μA	2.0	1.9	2.0	_	V
				4.5	4.4	4.5	_	
				6.0	5.9	6.0	_	
			$I_{OH}$ = -6 mA	4.5	4.18	4.31	_	
			I <sub>OH</sub> = -7.8 mA	6.0	5.68	5.80	_	
Low-level output voltage	V <sub>OL</sub>	V <sub>IN</sub> = V <sub>IH</sub> or V <sub>IL</sub>	$I_{OL}$ = 20 $\mu$ A	2.0		0.0	0.1	V
				4.5	_	0.0	0.1	
				6.0	_	0.0	0.1	
			I <sub>OL</sub> = 6 mA	4.5		0.17	0.26	
			I <sub>OL</sub> = 7.8 mA	6.0		0.18	0.26	
3-state output OFF-state leakage current	l <sub>OZ</sub>	$V_{IN} = V_{IH} \text{ or } V_{IL}$ $V_{OUT} = V_{CC} \text{ or GND}$		6.0	١	l	±0.5	μА
Input leakage current	I <sub>IN</sub>	$V_{IN} = V_{CC}$ or GND		6.0		_	±0.1	μА
Quiescent supply current	I <sub>CC</sub>	$V_{IN} = V_{CC}$ or GND		6.0	_		4.0	μА

# 11.2. DC Characteristics (Unless otherwise specified, $T_a$ = -40 to 85 °C)

Characteristics	Symbol	Test Condition		V <sub>CC</sub> (V)	Min	Max	Unit
High-level input voltage	V <sub>IH</sub>	_		2.0	1.50	_	V
				4.5	3.15	_	]
				6.0	4.20	_	
Low-level input voltage	V <sub>IL</sub>	_		2.0		0.50	V
				4.5		1.35	
				6.0		1.80	
High-level output voltage	V <sub>OH</sub>	V <sub>IN</sub> = V <sub>IH</sub> or V <sub>IL</sub>	I <sub>OH</sub> = -20 μA	2.0	1.9	_	V
				4.5	4.4	_	
				6.0	5.9	_	
			$I_{OH}$ = -6 mA	4.5	4.13	_	
			$I_{OH} = -7.8 \text{ mA}$	6.0	5.63	_	
Low-level output voltage	V <sub>OL</sub>	$V_{IN} = V_{IH}$ or $V_{IL}$	I <sub>OL</sub> = 20 μA	2.0		0.1	V
				4.5	ı	0.1	
				6.0		0.1	
			I <sub>OL</sub> = 6 mA	4.5		0.33	
			I <sub>OL</sub> = 7.8 mA	6.0	ı	0.33	
3-state output OFF-state leakage current	I <sub>OZ</sub>	$V_{IN} = V_{IH} \text{ or } V_{IL}$ $V_{OUT} = V_{CC} \text{ or GND}$		6.0	_	±5.0	μА
Input leakage current	I <sub>IN</sub>	$V_{IN} = V_{CC}$ or GND		6.0	_	±1.0	μА
Quiescent supply current	I <sub>CC</sub>	$V_{IN} = V_{CC}$ or GND		6.0	_	40.0	μА



# 11.3. AC Characteristics (Unless otherwise specified, $T_a$ = 25 °C, Input: $t_r$ = $t_f$ = 6 ns)

Characteristics	Part Number	Symbol	Note	Test Condition	C <sub>L</sub> (pF)	V <sub>CC</sub> (V)	Min	Тур.	Max	Unit
Output transition time		t <sub>TLH</sub> ,t <sub>THL</sub>			50	2.0	1	25	60	ns
						4.5		7	12	
						6.0		6	10	
Propagation delay time		t <sub>PLH</sub> ,t <sub>PHL</sub>			50	2.0	1	36	90	ns
						4.5		12	18	
						6.0	1	10	15	
					150	2.0	1	51	130	
						4.5		17	26	
						6.0		14	22	
Output enable time		$t_{PZL}, t_{PZH}$		$R_L = 1 k\Omega$	50	2.0	_	48	125	ns
						4.5	l	16	25	
						6.0		14	21	
					150	2.0	1	63	165	
						4.5	l	21	33	
						6.0		18	28	
Output disable time		$t_{PLZ}, t_{PHZ}$		$R_L = 1 k\Omega$	50	2.0	1	32	125	ns
						4.5	l	15	25	
						6.0	_	14	21	
Input capacitance		C <sub>IN</sub>						5	10	pF
Output capacitance		C <sub>OUT</sub>		_		_		10	_	pF
Power dissipation	74HC240D	C <sub>PD</sub>	(Note 1)	_				31		pF
capacitance	74HC244D						_	33		

Note 1:  $C_{PD}$  is defined as the value of the internal equivalent capacitance which is calculated from the operating current consumption without load. Average operating current can be obtained by the equation.  $I_{CC(opr)} = C_{PD} \times V_{CC} \times f_{|N} + I_{CC}/8 \text{ (per bit)}$ 

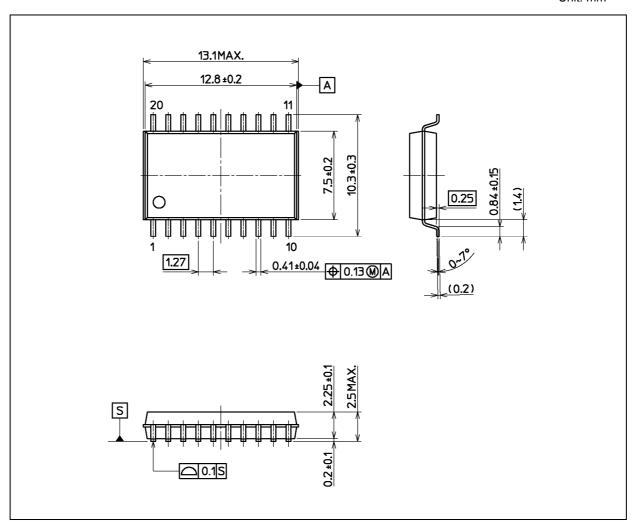
# 11.4. AC Characteristics (Unless otherwise specified, $T_a = -40$ to 85 °C, Input: $t_r = t_f = 6$ ns)

Characteristics	Symbol	Test Condition	C <sub>L</sub> (pF)	V <sub>CC</sub> (V)	Min	Max	Unit
Output transition time	t <sub>TLH</sub> ,t <sub>THL</sub>	_	50	2.0	_	75	ns
				4.5	_	15	
				6.0	_	13	]
Propagation delay time	t <sub>PLH</sub> ,t <sub>PHL</sub>	_	50	2.0	_	115	ns
				4.5	_	23	
				6.0	_	20	]
			150	2.0	_	165	
				4.5	_	33	]
				6.0	_	28	]
Output enable time	t <sub>PZL</sub> ,t <sub>PZH</sub>	$R_L = 1 k\Omega$	50	2.0	_	155	ns
				4.5	_	31	]
				6.0	_	26	]
			150	2.0	_	205	
				4.5	_	41	]
				6.0	_	35	]
Output disable time	$t_{PLZ}, t_{PHZ}$	$R_L = 1 k\Omega$	50	2.0	_	155	ns
				4.5	_	31	]
				6.0	_	26	
Input capacitance	C <sub>IN</sub>	_			_	10	pF



# **Package Dimensions**

Unit: mm



Weight: 0.51 g (typ.)

	Package Name(s)
Nickname: SOIC20	



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